

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Michael Beck	08/12/2008
Peter Lahnor	08/12/2008
Martin Kerber	08/29/2008
Roland Thewes	08/27/2008

RECEIVING PARTY DATA

Name:	Qimonda AG
Street Address:	Gustav-Heinemann-Ring 212
City:	Muenchen
State/Country:	GERMANY
Postal Code:	81739

Name:	Infineon Technologies AG
Street Address:	St.-Martin-Str. 53
City:	Muenchen
State/Country:	GERMANY
Postal Code:	81669

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12201223

CORRESPONDENCE DATA

Fax Number: (919)854-2084
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 919-854-1844
 Email: lwade@coatsandbennett.com
 Correspondent Name: Mark R. Bilak
 Address Line 1: 1400 Crescent Green, Suite 300

OP \$40.00 12201223

Address Line 2: Coats & Bennett, PLLC
Address Line 4: Cary, NORTH CAROLINA 27518

ATTORNEY DOCKET NUMBER:

5682-039

NAME OF SUBMITTER:

Mark R. Bilak

Total Attachments: 6
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ASSIGNMENT

For good and valuable consideration, I, Michael Beck, a citizen of Germany, residing at Am alten Bahndamm, 01328 Dresden, Germany, Martin Kerber, a citizen of Austria, residing at Florastr. 42, 81627 München, Germany, Peter Lahnor, a citizen of Germany, residing at Goethestr. 8, 01109 Dresden, Germany, and Roland Thewes, a citizen of Germany, residing at Jaegerheimstrasse 7, 82194 Groebenzell, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Qimonda AG**, having its principal place of business at Gustav-Heinemann-Ring 212, 81739 München, Germany and **Infineon Technologies AG**, having its principal place of business at St.-Martin-Str. 53, 81669 München, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on 29 Aug. 2008 US. Serial No. 12/201,223

entitled: **Method and Apparatus for Reducing Charge Trapping in High-K Dielectric Material**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____

Michael Beck

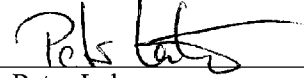
DATE: _____

08/12/08

SIGNATURE: _____ DATE: _____

Martin Kerber

SIGNATURE: _____ DATE: 08/12/2008



Peter Lahnor

SIGNATURE: _____ DATE: _____

Roland Thewes

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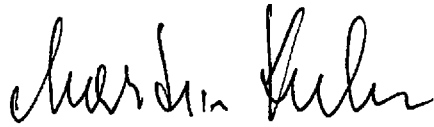
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Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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SIGNATURE: _____ DATE: _____
Michael Beck

SIGNATURE:  DATE: 29-Aug-2008
Martin Kerber

SIGNATURE: _____ DATE: _____
Peter Lahnor

SIGNATURE: _____ DATE: _____
Roland Thewes

001 919 854 2084

CLIENT REF. 2008P00395US
C&B REF. 5682-039

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C&B REF. 5682-039

SIGNATURE: _____ DATE: _____
Martin Kerber

SIGNATURE: _____ DATE: _____
Peter Lahnor

SIGNATURE: *Roland Thewes* DATE: August 27, 2008
Roland Thewes

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